

Welcome to **E-XFL.COM**

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, IrDA, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	19
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 5x10b
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.600", 15.24mm)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0822pj020sg

Table of Contents

Revision Historyii
List of Figuresx
List of Tables
Introduction
Features
Part Selection Guide
Block Diagram 3
CPU and Peripheral Overview
General Purpose Input/Output
Flash Controller
10-Bit Analog-to-Digital Converter
UART 5
I2C 5
Serial Peripheral Interface
Timers
Interrupt Controller
Reset Controller
On-Chip Debugger
Signal and Pin Descriptions
Available Packages
Pin Configurations
Signal Descriptions
Pin Characteristics
Address Space
Register File
Program Memory
Data Memory
Information Area
Register File Address Map
Reset and Stop Mode Recovery
Reset Types
System Reset
Reset Sources
Power-On Reset
Voltage Brown-Out Reset
Watchdog Timer Reset

Z8 Encore! XP[®] F0822 Series Product Specification



viii

Architecture	. 136
Operation	. 137
Automatic Power-Down	. 137
Single-Shot Conversion	. 137
Continuous Conversion	. 138
ADC Control Register Definitions	. 139
ADC Control Register	. 139
ADC Data High Byte Register	. 141
ADC Data Low Bits Register	. 142
Flash Memory	. 143
Information Area	
Operation	. 145
Timing Using the Flash Frequency Registers	
Flash Read Protection	
Flash Write/Erase Protection	. 146
Byte Programming	. 147
Page Erase	. 148
Mass Erase	. 148
Flash Controller Bypass	. 148
Flash Controller Behavior in Debug Mode	. 149
Flash Control Register Definitions	
Flash Control Register	
Flash Status Register	. 151
Page Select Register	. 152
Flash Sector Protect Register	
Flash Frequency High and Low Byte Registers	. 153
Option Bits	. 155
Operation	. 155
Option Bit Configuration By Reset	. 155
Option Bit Address Space	
Flash Memory Address 0000H	. 156
Flash Memory Address 0001H	. 157
On-Chip Debugger	. 158
Architecture	. 158
Operation	. 159
OCD Interface	. 159
Debug Mode	. 160
OCD Data Format	
OCD Autobaud Detector/Generator	
OCD Serial Errors	. 162

- the PWM High and Low Byte registers still contains 0000H after the interrupt, then the interrupt was generated by a reload.
- 5. If required, enable the timer interrupt and set the timer interrupt priority by writing to the relevant interrupt registers.
- 6. Configure the associated GPIO port pin for the Timer Input alternate function.
- 7. Write to the Timer Control Register to enable the timer and initiate counting.

In CAPTURE Mode, the elapsed time from timer start to capture event is calculated using the following equation:

 $\label{eq:capture Elapsed Time (s) = } \frac{(Capture\ Value\ -\ Start\ Value\)xPrescale}{System\ Clock\ Frequency\ (Hz)}$

COMPARE Mode

In COMPARE Mode, the timer counts up to the 16-bit maximum Compare value stored in the Timer Reload High and Low Byte registers. The timer input is the system clock. Upon reaching the Compare value, the timer generates an interrupt and counting continues (the timer value is not reset to 0001H). Also, if the Timer Output alternate function is enabled, the Timer Output pin changes state (from Low to High or from High to Low) upon Compare.

If the Timer reaches FFFFH, the timer rolls over to 0000H and continue counting.

Observe the following procedure for configuring a timer for COMPARE Mode and initiating the count:

- 1. Write to the Timer Control Register to:
 - Disable the timer
 - Configure the timer for COMPARE Mode
 - Set the prescale value
 - Set the initial logic level (High or Low) for the Timer Output alternate function, if required
- 2. Write to the Timer High and Low Byte registers to set the starting count value.
- 3. Write to the Timer Reload High and Low Byte registers to set the Compare value.
- 4. If required, enable the timer interrupt and set the timer interrupt priority by writing to the relevant interrupt registers.
- 5. If using the Timer Output function, configure the associated GPIO port pin for the Timer Output alternate function.
- 6. Write to the Timer Control Register to enable the timer and initiate counting.



Table 48. Watchdog Timer Control Register (WDTCTL)

Bit	7	6	5	4	3 2 1					4 3 2 1			0
Field	POR	STOP	WDT	EXT	Reserved								
RESET		See Ta	ble 49.		0								
R/W		R											
Address		FF0H											

Bit	Description
[7] POR	Power-On Reset Indicator If this bit is set to 1, a POR event occurred. This bit is reset to 0, if a WDT time-out or Stop Mode Recovery occurs. This bit is also reset to 0, when the register is read.
[6] STOP	Stop Mode Recovery Indicator If this bit is set to 1, a Stop Mode Recovery occurred. If the STOP and WDT bits are both set to 1, the Stop Mode Recovery occurred due to a WDT time-out. If the stop bit is 1 and the WDT bit is 0, the Stop Mode Recovery was not caused by a WDT time-out. This bit is reset by a POR or a WDT time-out that occurred while not in STOP Mode. Reading this register also resets this bit.
[5] WDT	Watchdog Timer Time-Out Indicator If this bit is set to 1, a WDT time-out occurred. A POR resets this pin. A Stop Mode Recovery due a change in an input pin also resets this bit. Reading this register resets this bit.
[4] EXT	External Reset Indicator If this bit is set to 1, a Reset initiated by the external RESET pin occurred. A POR or a Stop Mode Recovery from a change in an input pin resets this bit. Reading this register resets this bit.
[3:0]	Reserved These bits are reserved and must be programmed to 0000.

Table 49. Watchdog Timer Events

Reset or Stop Mode Recovery Event	POR	STOP	WDT	EXT
Power-On Reset	1	0	0	0
Reset through RESET pin assertion	0	0	0	1
Reset through WDT time-out	0	0	1	0
Reset through the OCD (OCTCTL[1] set to 1)	1	0	0	0
Reset from STOP Mode through the DBG Pin driven Low	1	0	0	0
Stop Mode Recovery through GPIO pin transition	0	1	0	0
Stop Mode Recovery through WDT time-out	0	1	1	0

117

SDA and SCL Signals

 I^2C sends all addresses, data and acknowledge signals over the SDA line, most-significant bit first. SCL is the common clock for the I^2C Controller. When the SDA and SCL pin alternate functions are selected for their respective GPIO ports, the pins are automatically configured for open-drain operation.

The master (I^2C) is responsible for driving the SCL clock signal, although the clock signal becomes skewed by a slow slave device. During the Low period of the clock, the slave pulls the SCL signal Low to suspend the transaction. The master releases the clock at the end of the Low period and notices that the clock remains Low instead of returning to a High level. When the slave releases the clock, the I^2C Controller continues the transaction. All data is transferred in bytes and there is no limit to the amount of data transferred in one operation. When transmitting data or acknowledging read data from the slave, the SDA signal changes in the middle of the Low period of SCL and is sampled in the middle of the High period of SCL.

I²C Interrupts

The I²C Controller contains four sources of interrupts: Transmit, Receive, Not Acknowledge and Baud Rate Generator. These four interrupt sources are combined into a single interrupt request signal to the interrupt controller. The transmit interrupt is enabled by the IEN and TXI bits of the control register. The Receive and Not Acknowledge interrupts are enabled by the IEN bit of the control register. BRG interrupt is enabled by the BIRQ and IEN bits of the control register.

Not Acknowledge interrupts occur when a Not Acknowledge condition is received from the slave or sent by the I²C Controller and neither the start or stop bit is set. The Not Acknowledge event sets the NCKI bit of the I²C Status Register and can only be cleared by setting the start or stop bit in the I²C Control Register. When this interrupt occurs, the I²C Controller waits until either the stop or start bit is set before performing any action. In an ISR, the NCKI bit should always be checked prior to servicing transmit or receive interrupt conditions because it indicates the transaction is being terminated.

Receive interrupts occur when a byte of data has been received by the I²C Controller (Master reading data from Slave). This procedure sets the RDRF bit of the I²C Status Register. The RDRF bit is cleared by reading the I²C Data Register. The RDRF bit is set during the acknowledge phase. The I²C Controller pauses after the acknowledge phase until the receive interrupt is cleared before performing any other action.

Transmit interrupts occur when the TDRE bit of the I²C Status Register sets and the TXI bit in the I²C Control Register is set. Transmit interrupts occur under the following conditions when the Transmit Data Register is empty:

• The I²C Controller is enabled

- The I²C Controller loads the contents of the I²C Shift Register with the contents of the I²C Data Register.
- 13. The I²C Controller shifts the data out of using the SDA signal. After the first bit is sent, the transmit interrupt is asserted.
- 14. If more bytes remain to be sent, return to Step 9.
- 15. Software responds by setting the stop bit of the I²C Control Register (or start bit to initiate a new transaction). In the STOP case, software clears the TXI bit of the I²C Control Register at the same time.
- 16. The I²C Controller completes transmission of the data on the SDA signal.
- 17. The slave can either Acknowledge or Not Acknowledge the last byte. Because either the stop or start bit is already set, the NCKI interrupt does not occur.
- 18. The I²C Controller sends the stop (or restart) condition to the I²C bus. The stop or start bit is cleared.

Address-Only Transaction with a 10-Bit Address

In situations in which software must determine if a slave with a 10-bit address is responding without sending or receiving data, a transaction is performed which only consists of an address phase. Figure 28 displays this *address only* transaction to determine if a slave with a 10-bit address will acknowledge.

As an example, this transaction is used after a write has been executed to an EEPROM to determine when the EEPROM completes its internal write operation and is again responding to I²C transactions. If the slave does not acknowledge, the transaction is repeated until the slave is able to acknowledge.

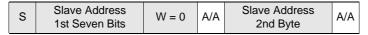


Figure 28. 10-Bit Address Only Transaction Format

Observe the following procedure for an address-only transaction to a 10-bit addressed slave:

- 1. Software asserts the IEN bit in the I²C Control Register.
- 2. Software asserts the TXI bit of the I^2C Control Register to enable transmit interrupts.
- 3. The I^2C interrupt asserts, because the I^2C Data Register is empty (TDRE = 1).
- 4. Software responds to the TDRE interrupt by writing the first slave address byte. The least-significant bit must be 0 for the write operation.
- 5. Software asserts the start bit of the I²C Control Register.

126

- 5. The I²C Controller shifts the address and read bit out the SDA signal.
- 6. If the I²C Slave acknowledges the address by pulling the SDA signal Low during the next High period of SCL, the I²C Controller sets the ACK bit in the I²C Status Register. Continue to Step 7.

If the slave does not acknowledge, the Not Acknowledge interrupt occurs (NCKI bit is set in the Status Register, ACK bit is cleared). Software responds to the Not Acknowledge interrupt by setting the stop bit and clearing the TXI bit. The I²C Controller sends the stop condition on the bus and clears the stop and NCKI bits. The transaction is complete; ignore the remainder of this sequence.

- 7. The I²C Controller shifts in the byte of data from the I²C Slave on the SDA signal. The I²C Controller sends a Not Acknowledge to the I²C Slave if the NAK bit is set (last byte), else it sends an Acknowledge.
- 8. The I²C Controller asserts the Receive interrupt (RDRF bit set in the Status Register).
- 9. Software responds by reading the I²C Data Register which clears the RDRF bit. If there is only one more byte to receive, set the NAK bit of the I²C Control Register.
- 10. If there are more bytes to transfer, return to Step 7.
- After the last byte is shifted in, a Not Acknowledge interrupt is generated by the I²C Controller.
- 12. Software responds by setting the stop bit of the I²C Control Register.
- 13. A stop condition is sent to the I²C Slave, the stop and NCKI bits are cleared.

Read Transaction with a 10-Bit Address

Figure 31 displays the read transaction format for a 10-bit addressed slave. The shaded regions indicate data transferred from the I²C Controller to slaves and unshaded regions indicate data transferred from the slaves to the I²C Controller.

S	Slave Address	W=0	Α	Slave Address	Α	S	Slave Address	R=1	Α	Data	Α	Data	Α	Р
	1st 7 bits			2nd Byte			1st 7 bits							

Figure 31. Receive Data Format for a 10-Bit Addressed Slave

The first seven bits transmitted in the first byte are 11110XX. The two XX bits are the two most significant bits of the 10-bit address. The lowest bit of the first byte transferred is the write control bit.

Observe the following procedure for the data transfer procedure for a read operation to a 10-bit addressed slave:

Flash Status Register

The Flash Status Register, shown in Table 85, indicates the current state of the Flash Controller. This register can be read at any time. The read-only Flash Status Register shares its Register File address with the write-only Flash Control Register.

Table 85. Flash Status Register (FSTAT)

Bit	7	6	5	5 4 3 2 1				0				
Field	Rese	erved		FSTAT								
RESET		0										
R/W		R										
Address		FF8H										

Bit	Description
[7:6]	Reserved
	These bits are reserved and must be programmed to 00.
[5:0]	Flash Controller Status
FSTAT	00_0000 = Flash Controller locked.
	00_0001 = First unlock command received.
	00_0010 = Second unlock command received.
	00_0011 = Flash Controller unlocked.
	00_0100 = Flash Sector Protect Register selected.
	00_1xxx = Program operation in progress.
	01_0xxx = Page erase operation in progress.
	10_0xxx = Mass erase operation in progress.

Exiting Debug Mode

The device exits DEBUG Mode following any of the following operations:

- Clearing the DBGMODE bit in the OCD Control Register to 0
- Power-On Reset
- Voltage Brown-Out reset
- Asserting the RESET pin Low to initiate a Reset
- Driving the DBG pin Low while the device is in STOP Mode initiates a System Reset

OCD Data Format

The OCD interface uses the asynchronous data format defined for RS-232. Each character is transmitted as 1 start bit, 8 data bits (least-significant bit first), and 1 stop bit; see Figure 37.



Figure 37. OCD Data Format

OCD Autobaud Detector/Generator

To run over a range of baud rates (bits per second) with various system clock frequencies, the OCD contains an Autobaud Detector/Generator. After a reset, the OCD is idle until it receives data. The OCD requires that the first character sent from the host is the character 80H. The character 80H has eight continuous bits Low (one start bit plus 7 data bits). The Autobaud Detector measures this period and sets the OCD Baud Rate Generator accordingly.

The Autobaud Detector/Generator is clocked by the system clock. The minimum baud rate is the system clock frequency divided by 512. For optimal operation, the maximum recommended baud rate is the system clock frequency divided by 8. The theoretical maximum baud rate is the system clock frequency divided by 4. This theoretical maximum is possible for low-noise designs with clean signals. Table 92 lists minimum and recommended maximum baud rates for sample crystal frequencies.

Bit	Description (Continued)
[4] BRKLOOP	Breakpoint Loop This bit determines what action the OCD takes when a BRK instruction is decoded if breakpoints are enabled (BRKEN is 1). If this bit is 0, then the DBGMODE bit is automatically set to 1 and the OCD enter DEBUG Mode. If BRKLOOP is set to 1, then the eZ8 CPU loops on the BRK instruction. 0 = BRK instruction sets DBGMODE to 1. 1 = eZ8 CPU loops on BRK instruction.
[3] BRKPC	Break When PC == OCDCNTR If this bit is set to 1, then the OCDCNTR Register is used as a hardware breakpoint. When the program counter matches the value in the OCDCNTR Register, DBGMODE is automatically set to 1. If this bit is set, the OCDCNTR Register does not count when the CPU is running. 0 = OCDCNTR is setup as counter. 1 = OCDCNTR generates hardware break when PC == OCDCNTR.
[2] BRKZRO	Break When OCDCNTR == 0000H If this bit is set, then the OCD automatically sets the DBGMODE bit when the OCDCNTR Register counts down to 0000H. If this bit is set, the OCDCNTR Register is not reset when the part leaves DEBUG Mode. 0 = OCD does not generate BRK when OCDCNTR decrements to 0000H. 1 = OCD sets DBGMODE to 1 when OCDCNTR decrements to 0000H.
[1]	Reserved This bit is reserved and must be programmed to 0.
[0] RST	Reset Setting this bit to 1 resets the Z8 Encore! XP® F0822 Series device. The device goes through a normal POR sequence with the exception that the OCD is not reset. This bit is automatically cleared to 0 when the reset finishes. 0 = No effect. 1 = Reset the Z8 Encore! XP® F0822 Series device.

Figure 45 displays the maximum current consumption in STOP Mode with the VBO and Watchdog Timer enabled plotted opposite the power supply voltage. All GPIO pins are configured as outputs and driven High.

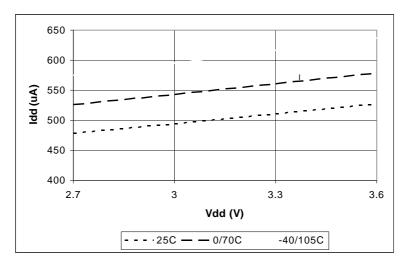


Figure 45. Maximum STOP Mode $I_{\mbox{\scriptsize DD}}$ with VBO Enabled vs. Power Supply Voltage

On-Chip Debugger Timing

Figure 50 and Table 108 provide timing information for the DBG pin. The DBG pin timing specifications assume a $4\mu s$ maximum rise and fall time.

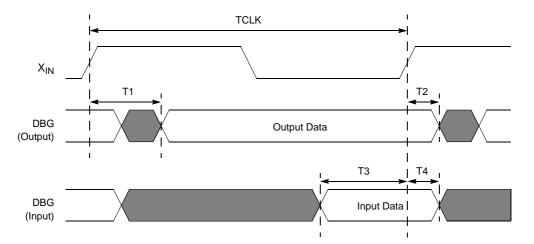


Figure 50. On-Chip Debugger Timing

Table 108. On-Chip Debugger Timing

		Delay (ns)			
Parameter	Abbreviation	Minimum	Maximum		
DBG					
T ₁	X _{IN} Rise to DBG Valid Delay	-	15		
T ₂	X _{IN} Rise to DBG Output Hold Time	2	-		
T ₃	DBG to X _{IN} Rise Input Setup Time	10	_		
T ₄	DBG to X _{IN} Rise Input Hold Time	5	-		
	DBG frequency		System Clock/4		

SPI MASTER Mode Timing

Figure 51 and Table 109 provide timing information for SPI MASTER Mode pins. Timing is shown with SCK rising edge used to source MOSI output data, SCK falling edge used to sample MISO input data. Timing on the SS output pin(s) is controlled by software.

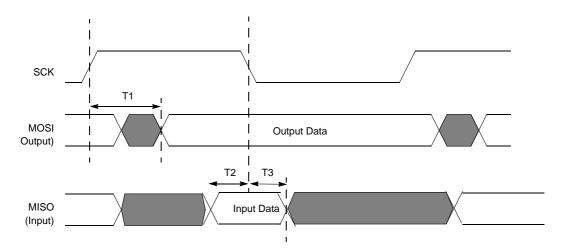


Figure 51. SPI MASTER Mode Timing

Table 109. SPI MASTER Mode Timing

		Delay (ns)				
Parameter	Abbreviation	Minimum	Maximum			
SPI MASTE	R					
T ₁	SCK Rise to MOSI output Valid Delay	-5	+5			
T ₂	MISO input to SCK (receive edge) Setup Time	20				
T ₃	MISO input to SCK (receive edge) Hold Time	0				

Condition Codes

The C, Z, S, and V flags control the operation of the conditional jump (JP cc and JR cc) instructions. Sixteen frequently useful functions of the flag settings are encoded in a 4-bit field called the condition code (cc), which forms Bits 7:4 of the conditional jump instructions. The condition codes are summarized in Table 118. Some binary condition codes can be created using more than one assembly code mnemonic. The result of the flag test operation decides if the conditional jump is executed.

Table 118. Condition Codes

Binary	Hex	Assembly Mnemonic	Definition	Flag Test Operation
0000	0	F	Always False	_
0001	1	LT	Less Than	(S XOR V) = 1
0010	2	LE	Less Than or Equal	(Z OR (S XOR V)) = 1
0011	3	ULE	Unsigned Less Than or Equal	(C OR Z) = 1
0100	4	OV	Overflow	V = 1
0101	5	MI	Minus	S = 1
0110	6	Z	Zero	Z = 1
0110	6	EQ	Equal	Z = 1
0111	7	С	Carry	C = 1
0111	7	ULT	Unsigned Less Than	C = 1
1000	8	T (or blank)	Always True	-
1001	9	GE	Greater Than or Equal	(S XOR V) = 0
1010	Α	GT	Greater Than	(Z OR (S XOR V)) = 0
1011	В	UGT	Unsigned Greater Than	(C = 0 AND Z = 0) = 1
1100	С	NOV	No Overflow	V = 0
1101	D	PL	Plus	S = 0
1110	Е	NZ	Non-Zero	Z = 0
1110	Е	NE	Not Equal	Z = 0
1111	F	NC	No Carry	C = 0
1111	F	UGE	Unsigned Greater Than or Equal	C = 0

Table 127. eZ8 CPU Instruction Summary (Continued)

Assembly	Symbolic		ress de	Op Code(s)			Fla	ags			Fetch	Instr.
Mnemonic	Operation	dst	src	(Hex)	С	Z	s	٧	D	Н	Cycles	Cycles
ADD dst, src	dst ← dst + src	r	r	02	*	*	*	*	0	*	2	3
		r	lr	03	_						2	4
		R	R	04	_						3	3
		R	IR	05	_					-	3	4
		R	IM	06	_						3	3
		IR	IM	07	-					-	3	4
ADDX dst, src	dst ← dst + src	ER	ER	08	*	*	*	*	0	*	4	3
		ER	IM	09	-					•	4	3
AND dst, src	dst ← dst AND src	r	r	52	-	*	*	0	-	-	2	3
		r	lr	53	-					-	2	4
		R	R	54	-					•	3	3
		R	IR	55	-					-	3	4
		R	IM	56	-					-	3	3
		IR	IM	57	-					-	3	4
ANDX dst, src	dst ← dst AND src	ER	ER	58	-	*	*	0	-	-	4	3
		ER	IM	59	-					-	4	3
BCLR bit, dst	dst[bit] ← 0	r		E2	-	-	-	-	-	-	2	2
BIT p, bit, dst	dst[bit] ← p	r		E2	-	-	-	-	-	-	2	2
BRK	Debugger Break			00	-	-	-	-	-	-	1	1
BSET bit, dst	dst[bit] ← 1	r		E2	-	-	-	-	-	-	2	2
BSWAP dst	dst[7:0] ← dst[0:7]	R		D5	Χ	*	*	0	-	-	2	2
BTJ p, bit, src,	if src[bit] = p		r	F6	-	-	-	-	-	-	3	3
dst	$PC \leftarrow PC + X$		lr	F7	-					-	3	4
BTJNZ bit, src,			r	F6	-	-	-	-	-	-	3	3
dst	$PC \leftarrow PC + X$		lr	F7	-					-	3	4
BTJZ bit, src,	if src[bit] = 0		r	F6	-	-	-	-	-	-	3	3
dst	$PC \leftarrow PC + X$		lr	F7	-					-	3	4

Note: Flags Notation:

^{* =} Value is a function of the result of the operation.

⁻ = Unaffected.

X = Undefined.

 $^{0 = \}text{Reset to } 0.$

^{1 =} Set to 1.

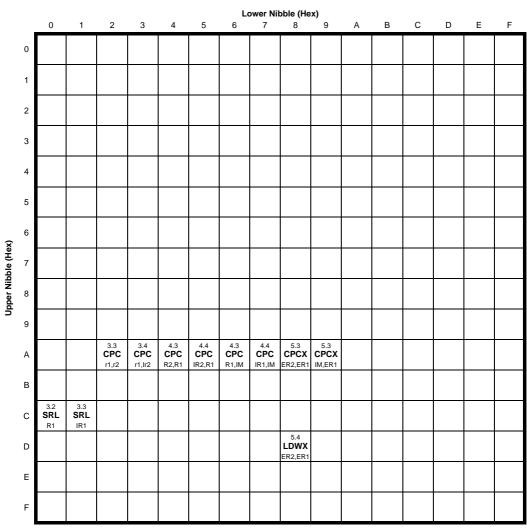


Figure 59. Second Op Code Map after 1FH

I²C Control Registers

For more information about the I^2C registers, see the <u>I2C Control Register Definitions</u> section on page 128.

Hex Address: F50

Table 155. I²C Data Register (I2CDATA)

Bit	7	6	5	4	3	2	1	0
Field				DA	·ΤΑ			
RESET				()			
R/W				R/	W			
Address				F5	0H			

Hex Address: F51

Table 156. I²C Status Register (I2CSTAT)

Bit	7	6	5	4	3	2	1	0
Field	TDRE	RDRF	ACK	10B	RD	TAS	DSS	NCKI
RESET	1				0			
R/W				F	₹			
Address				F5	1H			

Hex Address: F52

Table 157. I²C Control Register (I2CCTL)

Bit	7	6	5	4	3	2	1	0
Field	IEN	START	STOP	BIRQ	TXI	NAK	FLUSH	FILTEN
RESET				()			
R/W	R/W	R/W	R/W	R/W	R/W	R/W	W	R/W
Address				F5	2H			



Hex Address: FDA

Table 192. Port A-C Input Data Registers (PxIN)

Bit	7	6	5	4	3	2	1	0
Field	PIN7	PIN6	PIN5	PIN4	PIN3	PIN2	PIN1	PIN0
RESET)	(
R/W				F	₹			
Address				FD2H, FD	6H, FDAH			

Hex Address: FDB

Table 193. Port A-C Output Data Register (PxOUT)

Bit	7	6	5	4	3	2	1	0
Field	POUT7	POUT6	POUT5	POUT4	POUT3	POUT2	POUT1	POUT0
RESET				()			
R/W				R/	W			
Address				FD3H, FD	7H, FDBH			

Hex Addresses: FDC-FEF

This address range is reserved.

Watchdog Timer Control Registers

For more information about the Watchdog Timer control registers, see the <u>Watchdog Timer Control Register Definitions</u> section on page 73.

Hex Address: FF0

Table 194. Watchdog Timer Control Register (WDTCTL)

Bit	7	6	5	4	3	2	1	0
Field	POR	STOP	WDT	EXT		Rese	erved	
RESET	5	See <u>Table 49</u>	on page 74	ļ.		()	
R/W				F	₹			
Address				FF	0H			

Flash Control Registers

For more information about the Flash control registers, see the <u>Flash Control Register Definitions</u> section on page 149.

Hex Address: FF8

Table 198. Flash Control Register (FCTL)

Bit	7	6	5	4	3	2	1	0
Field				FC	MD			
RESET				()			
R/W				V	V			
Address				FF	8H			

Table 199. Flash Status Register (FSTAT)

Bit	7	6	5	4	3	2	1	0
Field	Rese	erved			FS	TAT		
RESET				()			
R/W				F	₹			
Address				FF	8H			

Hex Address: FF9

Table 200. Page Select Register (FPS)

Bit	7	6	5	4	3	2	1	0
Field	INFO_EN				PAGE			
RESET				()			
R/W				R/	W			
Address				FF	9H			



Ided in Life YS Company 253

RA 202 RR 202 rr 202 vector 202 X 202 notational shorthand 201 OCD architecture 158 autobaud detector/generator 161 baud rate limits 162 block diagram 158 breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 RR 202 on-chip debugger (OCD) 158 on-chip debugger (OCD) 158 on-chip debugger signals 12 on-chip oscillator 172 one-shot mode 68 opcode map abbreviations 218 cell description 218 first 219 second after 1FH 220 OPERATION OPE
rr 202 vector 202 X 202 notational shorthand 201 OCD architecture 158 autobaud detector/generator 161 baud rate limits 162 block diagram 158 breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 on-chip oscillator 172 one-shot mode 68 opcode map abbreviations 218 cell description 218 first 219 second after 1FH 220 OPerational Description 77 OR 207 ordering information 222 ORX 207 oscillator signals 11 Packaging 221 part selection guide 2 PC 202 peripheral AC and DC electrical characteristics 186 interface 159 PHASE=0 timing (SPI) 105
vector 202 X 202 notational shorthand 201 OCD architecture 158 autobaud detector/generator 161 baud rate limits 162 block diagram 158 breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debugger break 207 interface 159 ocel description 218 cell descriptio
notational shorthand 201 notational shorthand 201 abbreviations 218 cell description 218 first 219 second after 1FH 220 OCD OPerational Description 77 OR 207 architecture 158 autobaud detector/generator 161 baud rate limits 162 block diagram 158 breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 opcode map abbreviations 218 cell description 218 first 219 second after 1FH 220 OPR 207 ordering information 222 ORX 207 oscillator signals 11 P P P P P P P P P P P P
notational shorthand 201 abbreviations 218 cell description 218 first 219 second after 1FH 220 OCD Operational Description 77 OR 207 architecture 158 autobaud detector/generator 161 baud rate limits 162 ORX 207 block diagram 158 breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 abbreviations 218 cell description 218 first 219 second after 1FH 220 OPR 207 OPR 207 ordering information 222 ORX 207 oscillator signals 11 Packaging 221 part selection guide 2 PC 202 peripheral AC and DC electrical characteristics 186 interface 159 PHASE=0 timing (SPI) 105
cell description 218 first 219 second after 1FH 220 OCD Operational Description 77 OR 207 architecture 158 autobaud detector/generator 161 baud rate limits 162 block diagram 158 breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 Cell description 218 first 219 second after 1FH 220 ORX 207 ordering information 222 ORX 207 oscillator signals 11 P P P P P P P P P P P P
first 219 second after 1FH 220 OCD OPerational Description 77 OR 207 architecture 158 autobaud detector/generator 161 baud rate limits 162 ORX 207 block diagram 158 breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 First 219 second after 1FH 220 OPERATOR O
OCD
OCD architecture 158 autobaud detector/generator 161 baud rate limits 162 block diagram 158 breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debugger break 207 interface 159 OR 207 OR 207 ORX 207 ordering information 222 ORX 207 oscillator signals 11 P P P P P P P P P P P P
architecture 158 autobaud detector/generator 161 baud rate limits 162 block diagram 158 breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 OR 207 ordering information 222 ORX 207 oscillator signals 11 P P P P P P P P P P P P
autobaud detector/generator 161 baud rate limits 162 block diagram 158 breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 autobaud detector/generator 161 ordering information 222 ORX 207 oscillator signals 11 P P P P P P P P P P P P
baud rate limits 162 block diagram 158 breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 PRORX 207 oscillator signals 11 Packaging 221 part selection guide 2 PC 202 peripheral AC and DC electrical characteristics 186 PHASE=0 timing (SPI) 105
block diagram 158 breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 boscillator signals 11 P Packaging 221 part selection guide 2 PC 202 peripheral AC and DC electrical characteristics 186 pHASE=0 timing (SPI) 105
breakpoints 162 commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 Packaging 221 part selection guide 2 PC 202 peripheral AC and DC electrical characteristics 186 PHASE=0 timing (SPI) 105
commands 164 control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 Packaging 221 part selection guide 2 PC 202 peripheral AC and DC electrical characteristics 186 PHASE=0 timing (SPI) 105
control register 169 data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 Packaging 221 part selection guide 2 PC 202 peripheral AC and DC electrical characteristics 186 PHASE=0 timing (SPI) 105
data format 161 DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 Packaging 221 part selection guide 2 PC 202 peripheral AC and DC electrical characteristics 186 PHASE=0 timing (SPI) 105
DBG pin to RS-232 Interface 159 debug mode 160 debugger break 207 interface 159 part selection guide 2 PC 202 peripheral AC and DC electrical characteristics 186 PHASE=0 timing (SPI) 105
debug mode 160 PC 202 debugger break 207 peripheral AC and DC electrical characteristics 186 interface 159 PHASE=0 timing (SPI) 105
debugger break 207 peripheral AC and DC electrical characteristics 186 interface 159 PHASE=0 timing (SPI) 105
interface 159 PHASE=0 timing (SPI) 105
DILAGE 1 (included CDI) 100
serial errors 162 PHASE=1 timing (SPI) 106
status register 171 pin characteristics 13
timing 193 polarity 201
OCD commands POP 206
execute instruction (12H) 168 pop using extended addressing 206
read data memory (0DH) 168 POPX 206
read OCD control register (05H) 166 port availability, device 29
read OCD revision (00H) 165 port input timing (GPIO) 191
read OCD status register (02H) 165 port output timing, GPIO 192
read program counter (07H) 166 power supply signals 12
read program memory (0BH) 167 power-down, automatic (ADC) 137
read program memory CRC (0EH) 168 power-on and voltage brown-out electrical charac-
read register (09H) 167 teristics and timing 186
read runtime counter (03H) 165 power-on reset (POR) 22
step instruction (10H) 168 program control instructions 207
stuff instruction (11H) 168 program counter 202
write data memory (0CH) 167 program flash
write OCD control register (04H) 166 configurations 143
write program counter (06H) 166 program memory 15, 143
write program memory (0AH) 167 PUSH 206
write register (08H) 166 push using extended addressing 206
on-chip debugger 5 PUSHX 206